

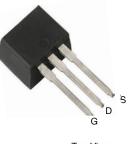
ROHS COMPLIANT

# AUF2804WL-VB Datasheet

N-Channel 40 V (D-S) MOSFET

PRODUCT SUMMARY					
V <sub>DS</sub> (V)	R <sub>DS(on)</sub> (Ω)	I <sub>D</sub> (A) <sup>a, c</sup> Q <sub>g</sub> (Ty			
40	0.0017 at V <sub>GS</sub> = 10 V	150	120 nC		
40	0.0025 at $V_{GS}$ = 4.5 V	135	120110		





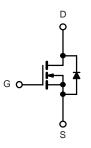
Top View

## FEATURES

- Trench Power MOSFET
- 100 % Rg and UIS Tested

#### **APPLICATIONS**

- Synchronous Rectification
- Power Supplies



N-Channel MOSFET

ABSOLUTE MAXIMUM RATING	Symbol	Limit	Unit	
Drain-Source Voltage	V <sub>DS</sub>	40		
Gate-Source Voltage	V <sub>GS</sub>	± 25	V	
	T <sub>C</sub> = 25 °C		150 <sup>a, c</sup>	
Continuous Drain Current (T 175 °C)	T <sub>C</sub> = 70 °C		120 <sup>c</sup>	
Continuous Drain Current (T <sub>J</sub> = 175 °C)	T <sub>A</sub> = 25 °C	I <sub>D</sub>	29 <sup>b</sup>	Α
	T <sub>A</sub> = 70 °C		23 <sup>b</sup>	A
Pulsed Drain Current	I <sub>DM</sub>	380	1	
Avalanche Current Pulse	L = 0.1 mH	I <sub>AS</sub>	80	
Single Pulse Avalanche Energy		E <sub>AS</sub>	320	mJ
Continuous Source-Drain Diode Current	T <sub>C</sub> = 25 °C	I <sub>S</sub>	110 <sup>a, c</sup>	Α
Continuous Source-Drain Diode Current	T <sub>A</sub> = 25 °C	'S	2.6 <sup>b</sup>	A
	T <sub>C</sub> = 25 °C		312 <sup>a</sup>	
Maximum Dawar Dissinction	T <sub>C</sub> = 70 °C	P <sub>D</sub>	200	w
Maximum Power Dissipation	T <sub>A</sub> = 25 °C		3.13 <sup>b</sup>	vv
	T <sub>A</sub> = 70 °C		2.0 <sup>b</sup>	
Operating Junction and Storage Temperature Ra	T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150	°C	

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient <sup>b</sup>	Steady State	R <sub>thJA</sub>	32	40	°C/W	
Maximum Junction-to-Case	Steady State	R <sub>thJC</sub>	0.33	0.4	C/VV	

Notes:

a. Based on T<sub>C</sub> = 25 °C.

b. Surface Mounted on 1" x 1" FR4 board.

c. Calculated based on maximum junction temperature. Package limitation current is 110 A.

<b>SPECIFICATIONS</b> $T_J = 25 \text{ °C}, \text{ U}$ Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static	Symbol	Test conditions	IVIIII.	тур.	WidX.		
Drain-Source Breakdown Voltage	V <sub>DS</sub>	V <sub>GS</sub> = 0 V, I <sub>D</sub> = 250 μA	45			V	
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	VGS - 0 V, 10 - 200 p. (	-10	41		, v	
V <sub>GS(th)</sub> Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I <sub>D</sub> = 250 μA		- 8		mV/°C	
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	1.2	Ŭ	2.5	V	
Gate-Source Leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$	1.2		± 100	nA	
Gale-Source Leakage	GSS	$V_{DS} = 40 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			± 100		
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	$V_{DS} = 40 \text{ V}, V_{GS} = 0 \text{ V}$ $V_{DS} = 40 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55 \text{ °C}$			10	μA	
On Otata Daria Orana di	1	$V_{DS} = 40 \text{ V}, V_{GS} = 0 \text{ V}, 1 \text{ J} = 55 \text{ C}$ $V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	100		10		
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>		120	0.0047		A	
Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 30 \text{ A}$		0.0017		Ω	
		$V_{GS} = 4.5 \text{ V}, I_D = 20 \text{ A}$		0.0025		<u> </u>	
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = 15 V, I <sub>D</sub> = 30 A		180		S	
Dynamic <sup>b</sup>				-	-	1	
Input Capacitance	C <sub>iss</sub>			9000			
Output Capacitance	C <sub>oss</sub>	$V_{DS}$ = 20 V, $V_{GS}$ = 0 V, f = 1 MHz		650		pF	
Reverse Transfer Capacitance	C <sub>rss</sub>			450			
Total Gate Charge	Qg			120	180	_	
Gate-Source Charge	Q <sub>gs</sub>	$V_{DS} = 20$ V, $V_{GS} = 10$ V, $I_{D} = 20$ A		30		nC	
Gate-Drain Charge	Q <sub>gd</sub>			16			
Gate Resistance	Rg	f = 1 MHz		0.85	1.3	Ω	
Turn-On Delay Time	t <sub>d(on)</sub>			20	30		
Rise Time	t <sub>r</sub>	$V_{DD}$ = 20 V, $R_L$ = 1.0 $\Omega$		11	17		
Turn-Off Delay Time	t <sub>d(off)</sub>	${\rm I}_{\rm D} \cong$ 20 A, ${\rm V}_{\rm GEN}$ = 10 V, ${\rm R}_{\rm g}$ = 1 $\Omega$		77	115	]	
Fall Time	t <sub>f</sub>			10	15		
Turn-On Delay Time	t <sub>d(on)</sub>			102	155	ns	
Rise Time	t <sub>r</sub>	$V_{DD}$ = 20 V, $R_L$ = 1.0 $\Omega$		62	95		
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D \cong 20$ A, $V_{GEN}$ = 4.5 V, $R_g$ = 1 $\Omega$		180	270		
Fall Time	t <sub>f</sub>			60	90	1	
Drain-Source Body Diode Characteristics	s						
Continuous Source-Drain Diode Current	۱ <sub>S</sub>	T <sub>C</sub> = 25 °C			110		
Pulse Diode Forward Current <sup>a</sup>	I <sub>SM</sub>			1	200	A	
Body Diode Voltage	V <sub>SD</sub>	I <sub>S</sub> = 20 A		0.8	1.2	V	
Body Diode Reverse Recovery Time	t <sub>rr</sub>			50	75	ns	
Body Diode Reverse Recovery Charge Q.,				70	105	nC	
Reverse Recovery Fall Time	t <sub>a</sub>	I <sub>F</sub> = 20 A, di/dt = 100 A/μs, T <sub>J</sub> = 25 °C		30		ns	
Reverse Recovery Rise Time	t <sub>b</sub>			20			

Notes:

a. Pulse test; pulse width  $\leq$  300  $\mu s,$  duty cycle  $\leq$  2 %.

b. Guaranteed by design, not subject to production testing.

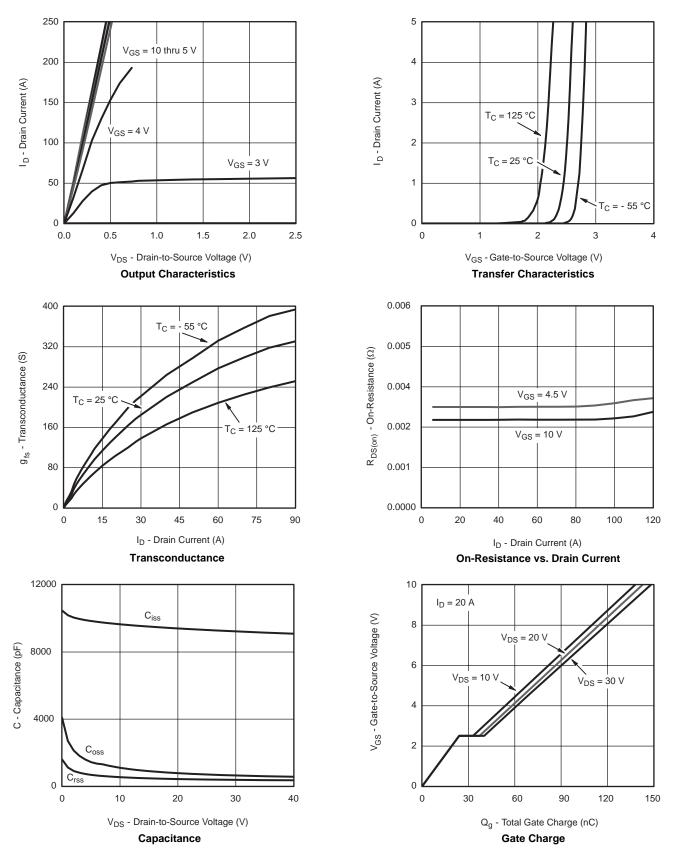
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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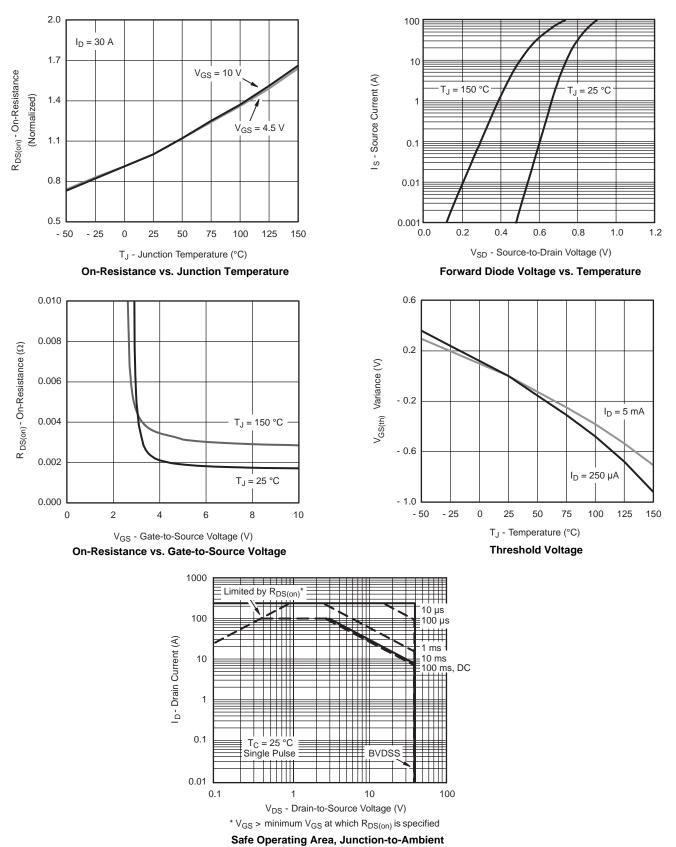
## TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



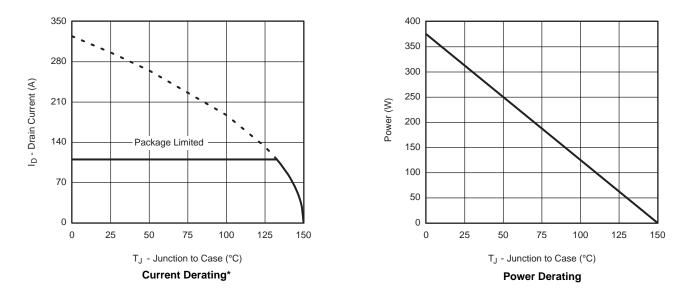
服务热线:400-655-8788



## TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

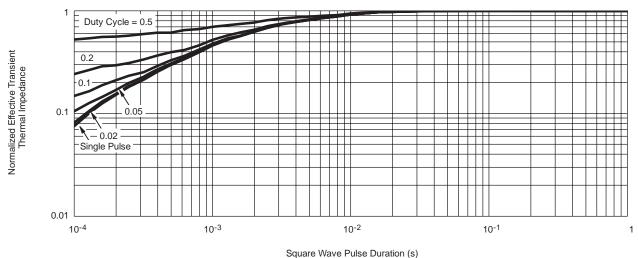






#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

\* The power dissipation  $P_D$  is based on  $T_{J(max)}$  = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

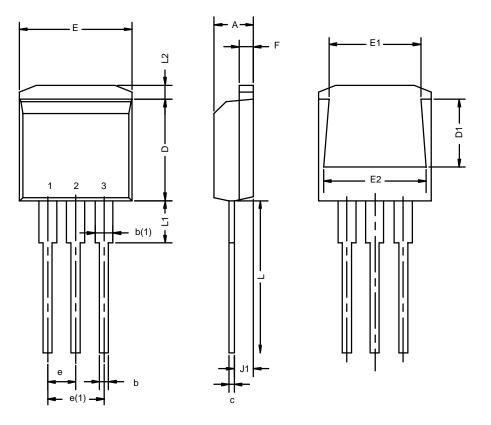


Normalized Thermal Transient Impedance, Junction-to-Case

# AUF2804WL-VB



## TO-262: 3-LEAD



	MILLIM	ETERS*	INC	CHES		
Dim	Min	Max	Min	Max		
Α	4.32	4.70	0.170	0.185		
b	0.64	1.00	0.025	0.039		
b(1)	1.14	1.40	0.045	0.055		
C	0.36	0.50	0.014	0.020		
D	8.64	9.65	0.340	0.380		
D1	5.59	6.10	0.220	0.240		
е	2.41	2.67	0.095	0.105		
e(1)	4.95	5.33	0.195	0.210		
E	10.03	10.41	0.395	0.410		
E1	7.87	8.64	0.310	0.340		
E2	9.02	9.53	0.355	0.375		
F	1.14	1.40	0.045	0.055		
J1	2.41	2.79	0.095	0.110		
L	13.08	14.22	0.515	0.560		
L1	-	3.81	-	0.150		
L2	1.02	1.40	0.040	0.055		
ECN: T-02234—Rev. C, 14-Oct-02 DWG: 5855						

\*Use millimeters as the primary measurement



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